FAIRCHILD

SEMICONDUCTOR®

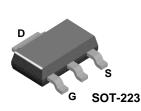
FQT7N10L N-Channel QFET[®] MOSFET 100 V, 1.7 A, 350 mΩ

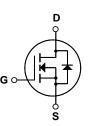
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 1.7 A, 100 V, $R_{DS(on)}$ =350 m Ω (Max.) @V_{GS}=10 V, I_D=0.85 A
- Low Gate Charge (Typ. 5.8 nC)
- Low Crss (Typ. 10 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQT7N10L	Unit
V _{DSS}	Drain-Source Voltage		100	V
I _D	Drain Current - Continuous (T _C = 25°	°C)	1.7	А
	- Continuous (T _C = 70°C)		1.36	А
I _{DM}	Drain Current - Pulsed	(Note 1)	6.8	А
V _{GSS}	Gate-Source Voltage		± 20	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	50	mJ
I _{AR}	Avalanche Current	(Note 1)	1.7	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.2	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
P _D	Power Dissipation ($T_C = 25^{\circ}C$)		2.0	W
	- Derate above 25°C		0.016	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

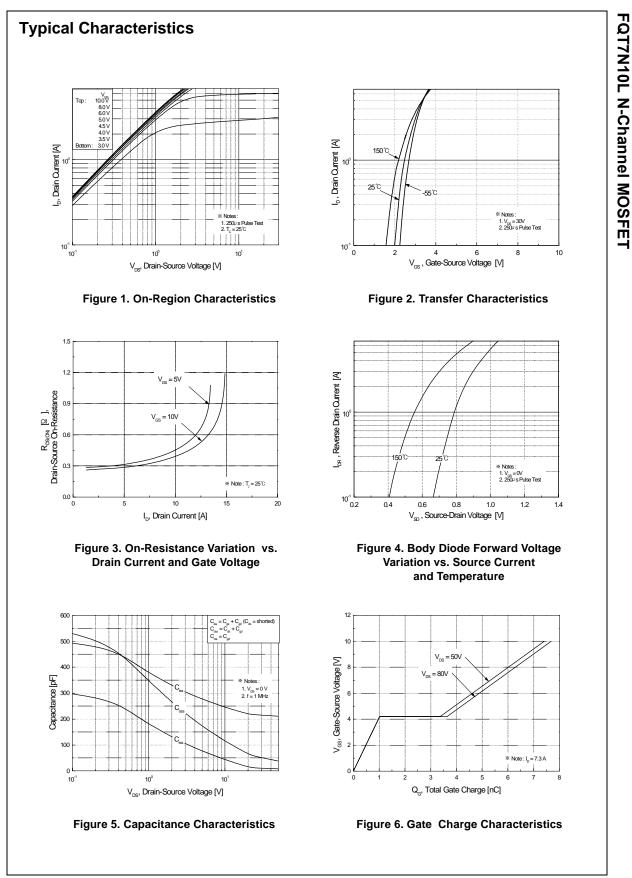
Thermal Characteristics

Symbol	Parameter	Тур	Max	Unit
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient *		62.5	°C/W

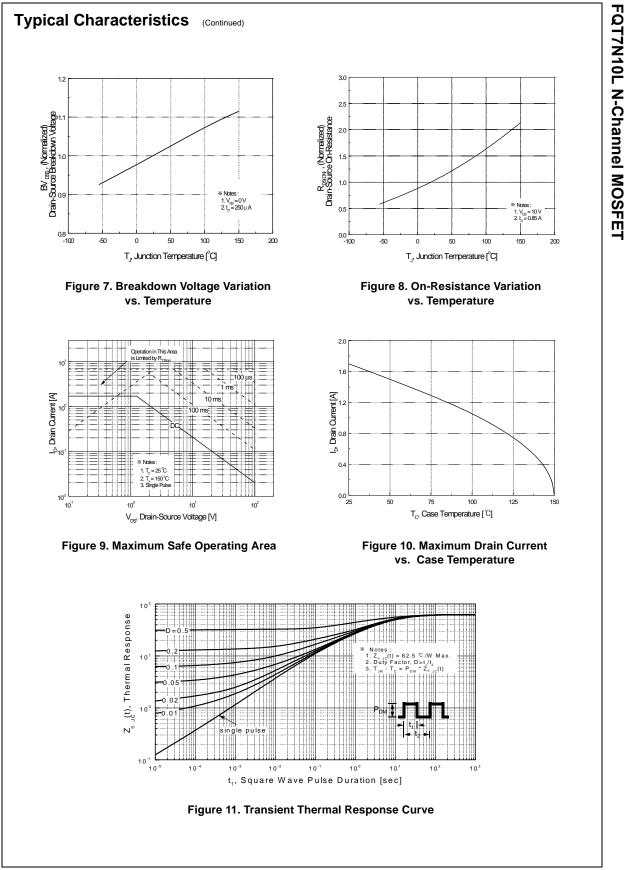
www.fairchildsemi.com

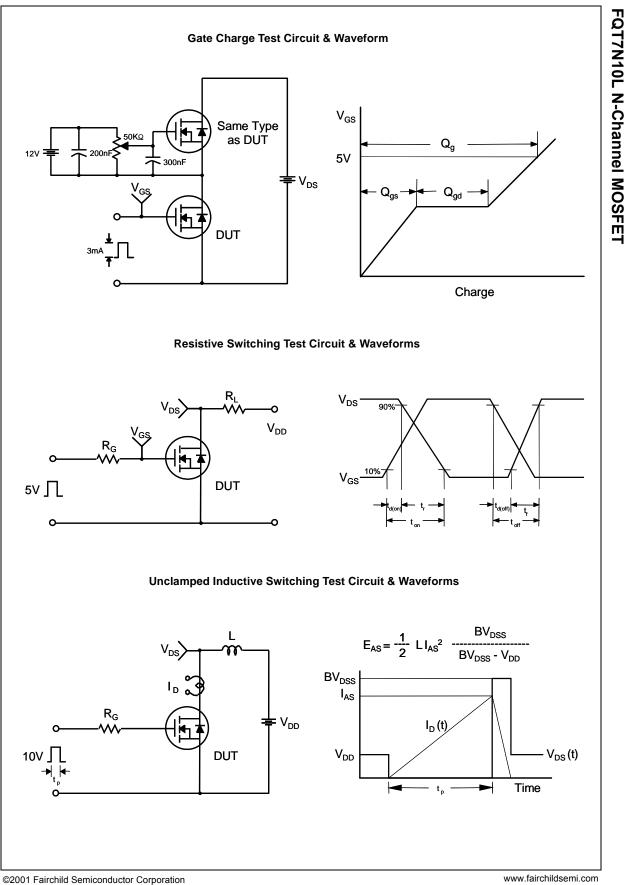
March 2013

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	100			V
ΔBV _{DSS} / ΔΤ.	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C		0.1		V/°C
		V _{DS} = 100 V, V _{GS} = 0 V			1	μA
	Zero Gate Voltage Drain Current	V _{DS} = 80 V, T _C = 125°C			10	μA
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	1.0		2.0	V
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.85 \text{ A}$		0.275	0.35	_
20(01)	On-Resistance	$V_{GS} = 5 \text{ V}, \text{ I}_{D} = 0.85 \text{ A}$		0.300	0.38	Ω
Øfs	Forward Transconductance	V _{DS} = 30 V, I _D = 0.85 A (Note 4)		2.75		S
Dynami	ic Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		220	290	pF
C _{oss}	Output Capacitance	$v_{DS} = 25 v, v_{GS} = 0 v,$ f = 1.0 MHz		55	72	pF
C _{rss}	Reverse Transfer Capacitance			12	15	pF
d(on) r	ng Characteristics Turn-On Delay Time Turn-On Rise Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 7.3 \text{ A},$ $\text{R}_{\text{G}} = 25 \ \Omega$		9 100	30 210	ns ns
d(off)	Turn-Off Delay Time Turn-Off Fall Time	(Note 4, 5)		17 50	45 110	ns
^t f Q _g	Total Gate Charge			4.6	6.0	ns nC
Q _{gs}	Gate-Source Charge	$V_{DS} = 80 \text{ V}, \text{ I}_{D} = 7.3 \text{ A},$		1.0		nC
∝ _{gs} Q _{gd}	Gate-Drain Charge	V _{GS} = 5 V (Note 4, 5)		2.6		nC
	, i i i i i i i i i i i i i i i i i i i			2.0		110
brain-5	ource Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current				1.7	A
I _{SM}		Maximum Pulsed Drain-Source Diode Forward Current			6.8	A
V _{SD}	Drain-Source Diode Forward Voltage				1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 7.3 A,$		70		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 \text{ A/}\mu\text{s}$ (Note 4)		140		nC
L = 26mH, I _µ I _{SD} \leq 7.3A, Pulse Test :	ating : Pulse width limited by maximum junction temper $_{AS}$ = 1.7A, V _{DD} = 25V, R _G = 25 Ω , Starting T _J = 25°C di/dt \leq 300A/µs, V _{DD} \leq BV _{DSS} , Starting T _J = 25°C Pulse width \leq 300µs, Duty cycle \leq 2% ndependent of operating temperature	rature				



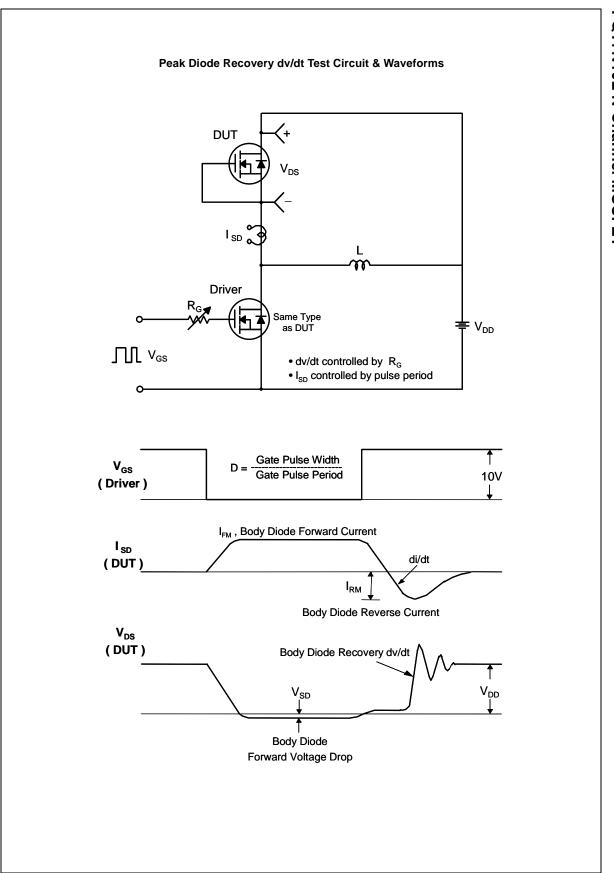
©2001 Fairchild Semiconductor Corporation FQT7N10L Rev. C0

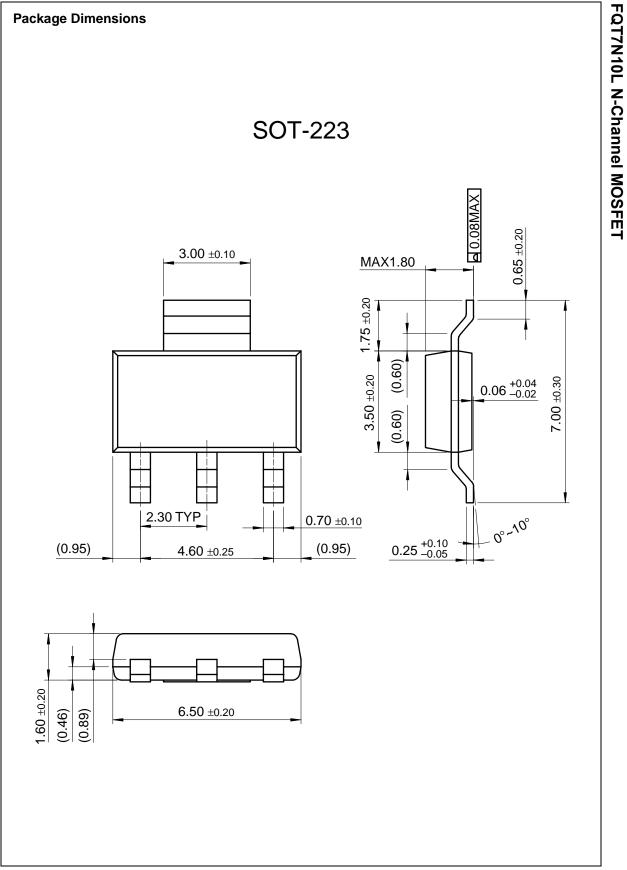




FQT7N10L Rev. C0

www.fairchildsemi.com





www.fairchildsemi.com



SEMICONDUCTOF

FQT7N10L N-Channel MOSFET

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

R

2Cool™ AccuPower™ AX-CAP[®]* BitSiC™ Build it Now™ CorePLUS™ **CorePOWER™** CROSSVOLT™ CTL™ Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK[®] EfficentMax™ ESBC™ (R)

+ Fairchild® Fairchild Semiconductor® FACT Quiet Series™ FACT® FAST® FastvCore™ FETBench™

FRFET® Global Power ResourceSM Green Bridge™ Green FPS™ Green FPS™ e-Series™ Gmax™ GTO™ IntelliMAX™ **ISOPLANAR™** Marking Small Speakers Sound Louder and Better™ MegaBuck™ MIČROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver™ OptoHiT™ **OPTOLOGIC[®] OPTOPLANAR[®]**

EDS TM

F-PFS™

PowerTrench[®] PowerXS[™] Programmable Active Droop™ QFET[®] QS™ Quiet Series™ RapidConfigure[™] тм ng our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ Solutions for Your Success™ SPM® STEALTH™ SuperFET[®] SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™

Sync-Lock™ SYSTEM^{®*} GENERAL TinyBoost™ TinyBuck™ TinyCalc™ TinyLogic® TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC® TriFault Detect™ TRUECURRENT®* µSerDes™ UHC® Ultra FRFET™ UniFET™ VCX[™] VisualMax™ VoltagePlus™

XS™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.